

Sparse Optical Flow (SOF) Demo Algorithm



October 6, 2015

1. Sparse Optical Flow (SOF) Demo algorithm

This sparse optical flow (SOF) algorithm uses Lucas Kanade tracker as basic tracker (flow vector compute) module. This particular demo algorithm shows creating an SOF algorithm using below 5 applets

- Image/YUV Padding
- Image Pyramid Creation
- Harris corner detection.
- Fast 9 corner Detection
- Best Feature to front using Fast9 Score and applying NMS
- Pyramidal Lucas Kanade tracker

The interface details of each of these applets can be found as part of EVE_Applets_UserGuide located in apps/docs drectory.

- The SOF algorithm accepts one 8-bit gray scale image for every process call and computes location of keypoints detected/tracked in the previous frame.
- Since the LK tracker algorithm requires two frames to compute the flow vector, the first frame supplied to SOF algorithm will be just used for creating image pyramid and will not produce any tracking information.
- The second frame onwards, the flow vector will be computed for the detected/tracked key points using image pyramid of current frame and the previous frame. The image pymaid of current frma will be intaernaly maintained and will be used in the next call as a previous frames with out re-computing again.
- The SOF algorithm supports below three methods for detecting key points
 1. External key points from user
 2. Harris corener detection applet
 3. Fast9 Key point detection along with best feature from applet
- This SOF demo supports a algorithm to track key points across multiple frames.
 - Detects the key points at every user defined number of frames.
 - Filters the key points with error estimates heigher thaa the user defined value.
 - Supress the detected/tracked key points with in user defined window size

The algorithm is supplied with a test bench to demonstrate the usage and interface.

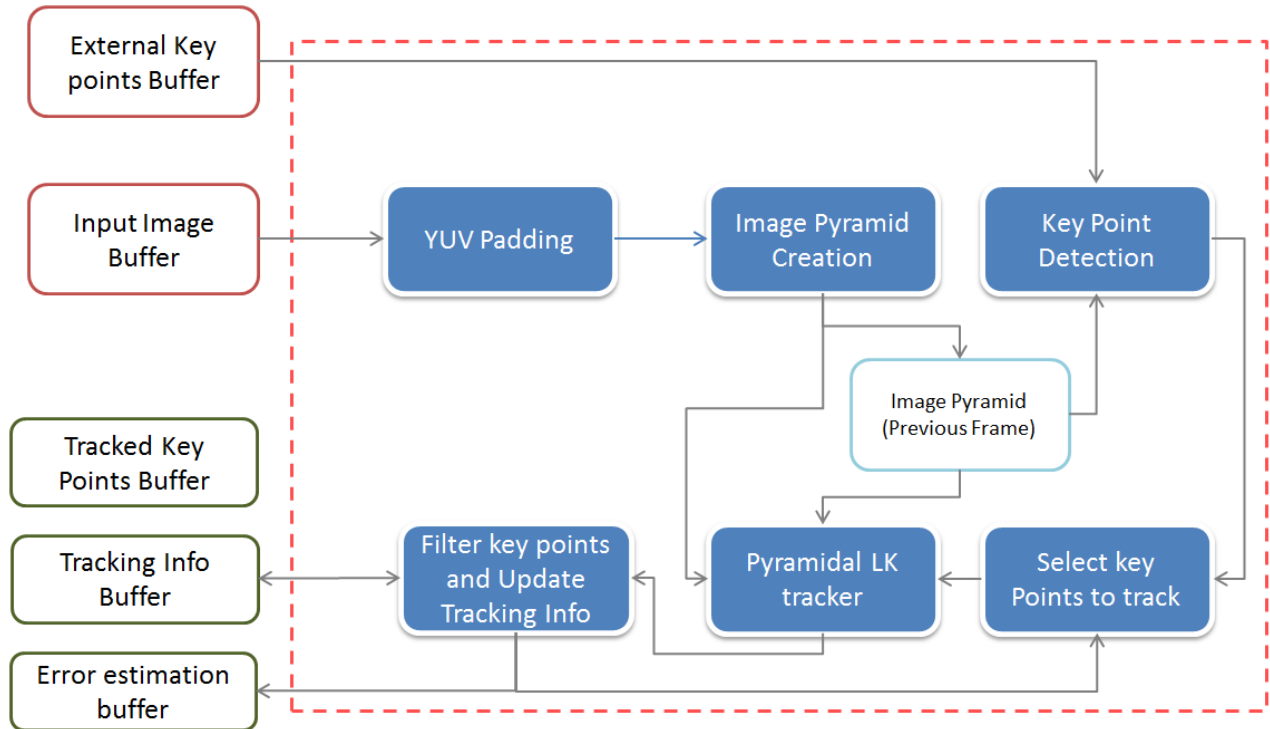


Figure 1 SOF Algorithm Data flow

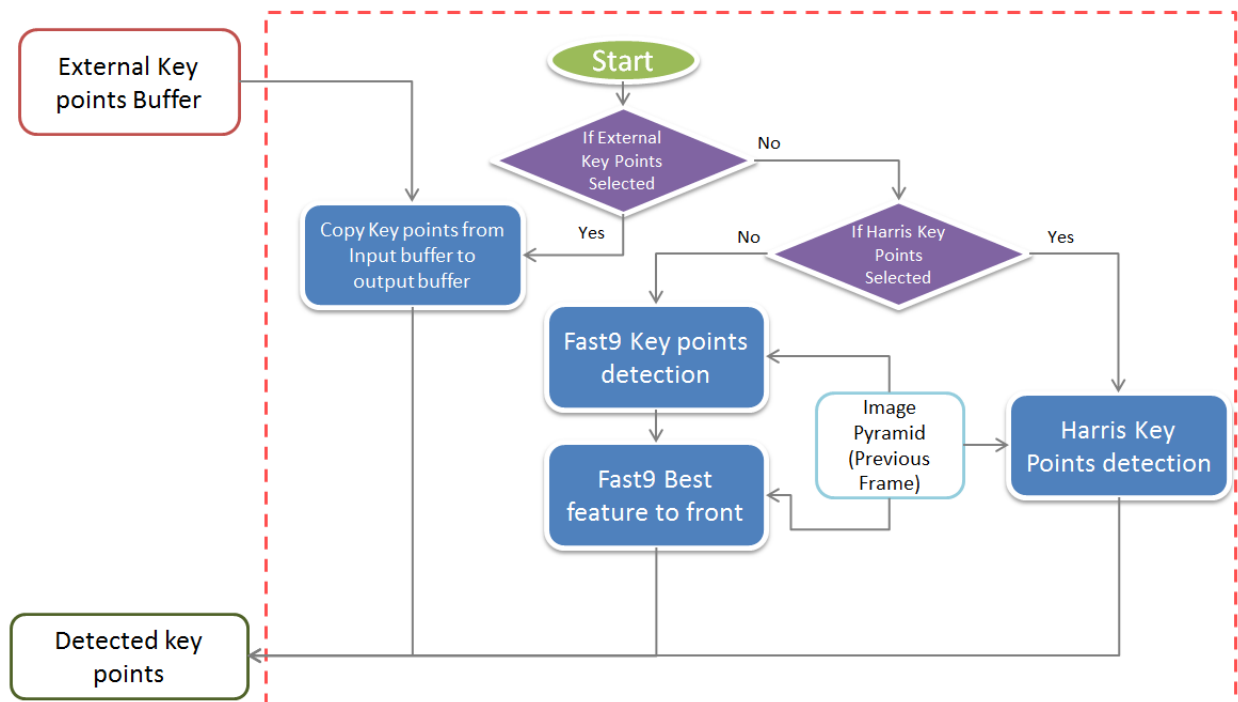


Figure 2 Key Points detection module flow

2. Data Structures

2.1 SOF_TI_CreateParams

|| Description

This structure defines the creation parameters for SOF algorithm

|| Fields

Field	Data Type	Input/ Output	Description
visionParams	IVISION_Pa rams	Input	Commom structure for vision modules
imWidth	uint16_t	Input	Width in bytes for the input image
imHeight	uint16_t	Input	Height in bytes for the input image
roiWidth	uint16_t	Input	Processing region width
roiHeight	uint16_t	Input	Processing region height
startX	uint16_t	Input	X co-ordinate of the first (top-left) pixel in the image. Useful for a ROI processing in a bigger image. Though the information about ROI is supplied via iVISION buf desc but create time also this information is required as this algorithm use the XY value as some create time initialization. It is for base level only.
startY	uint16_t	Input	Y co-ordinate of the first (top-left) pixel in the image. Useful for a ROI processing in a bigger image. Though the information about ROI is supplied via iVISION buf desc but create time also this information is required as this algorithm use the XY value as some create time initialization. It is for base level only
numLevels	uint8_t	input	Total number of pyramid levels including base level (1 means only base resolution)
keyPointDetectMethod	uint8_t	input	The key points in the image can be detetcted can be selected using this parameter
keyPointDetectInterva l	uint8_t	input	key point detection interval in number of frames. Setting to zero detects the key points in each frame

Field	Data Type	Input/ Output	Description
maxNumKeyPoints	uint16_t	input	Maximum number of frames that need to be detected by the algorithm
fast9Threshold	uint16_t	Input	Threshold on difference between intensity of the central pixel and pixels of a circle around this pixel for FAST9 corner detect applet.
scoreMethod	uint8_t	Input	Method for FAST9 Score – this score is used for best feature to front. ORB_TI_THRESH_METHOD and ORB_TI_SAD_METHOD are supported values
harrisScaling	uint16_t	Input	Scale foactor used in Harris score computation
harrisScoreMethod	uint8_t	Input	Method to use for Harris Score calculation. Refer tos HARRIS_CORNER_DETECTION_32_TI_Ha rrisScoreMethod for valid values defined in "iHarrisCornerDetection32_ti.h" file
harrisWindowSize	uint8_t	Input	Window size to be used for harris score calculation. Considers a harrisWindowSize x harrisWindowSize neighborhood to calculate Harris Score. Kindly refer to HARRIS_CORNER_DETECTION_32_TI_Ha rrisWindowSize for valid values in "iHarrisCornerDetection32_ti.h" file
suppressionMethod	uint8_t	Input	Suppression method to be used for non maximum suppression. Kindly refer to HARRIS_CORNER_DETECTION_32_TI_Su ppressionMethod for valid values in "iHarrisCornerDetection32_ti.h" file
nmsThreshold	uint32_t	Input	NMS threshold for harris corner detection applet
maxItersLK[PYRAMID_LK_TRACKER_TI_MAXLEVELS]	uint16_t	input	Maximum number of iterations for the iterative loop of pyramid LK tracker applet. This value can be set individually for each level.

Field	Data Type	Input/ Output	Description
<code>minErrValue[PYRAMID_LK_TRACKER_TI_MAXLEVELS]</code>	<code>uint16_t</code>	Input	Minimum flow vector difference value at any iteration of a given pyramid level. This input is represented using Q10 format. If the motion detected for a given point is less than or equal to this threshold, then it is considered as negligible motion and thereby invokes exit from the iterative loop of pyramid LK tracker. This value can be set individually for each level.
<code>searchRange[PYRAMID_LK_TRACKER_TI_MAXLEVELS];</code>	<code>uint8_t</code>	Input	Search range in pixel for each level

2.1.1.1 SOF_TI_InArgs

|| Description

This structure contains all the input parameters which are given to SOF algorithm at each process call.

|| Fields

Field	Data Type	Input/ Output	Description
<code>iVisionInArgs</code>	<code>IVISION_InArgs</code>	Input	Common inArgs for all ivison based modules
<code>numCorners</code>	<code>int32_t</code>	Input	Number of valid corners that need to be tracked. This parameter will be used only when <code>SOF_KeyPointDetectMethod</code> is <code>SOF_EXTERNAL_KEY_POINTS</code> .
<code>trackErrThr</code>	<code>uint32_t</code>	Input	Estimated error of each key point will be compared against this threshold. If the error is below then this threshold then the key will be considered for tracking in next frame
<code>trackMinFlowQ4</code>	<code>uint32_t</code>	Input	Minimum flow absolute ($\text{abs}(vx) + \text{abs}(vy)$) flow vector of key point that needs to be considered for tracking in next frame
<code>trackNmsWinSize</code>	<code>uint32_t</code>	Input	Number of neighbouring pixel (in each direction) to be considered for non maximum suppression while considered key poits to track in next frame.
<code>reserved0</code>	<code>uint8_t</code>	Input	This reserved parameter needs to be set to 0 for optimal performance.

2.1.1.2 SOF_TI_OutArgs

|| Description

This structure contains all the parameters which are given as an output by SOF algorithm.

|| Fields

Field	Data Type	Input/ Output	Description
iVisionOutArgs	IVISION_Pa rams	Output	Commom structure for outArgs ivision modules
numCorners	int32_t	Output	Total number of Key points (corners) that is beignt tracked in this frame

2.1.1.3 strackInfo

|| Description

This structure contains tracking information for each key points.

|| Fields

Field	Data Type	Input/ Output	Description
age	uint16_t	Output	Age of the current key points that is being tracked. If the age is zero then the key point is not valid. After 65535 ($2^{16} - 1$) age will be set to (65535 - MAX_NUM_FRAMES_TO_TRACK)
x	uint16_t	Output	Array of horizontal co-ordinates in Q4 format for MAX_NUM_FRAMES_TO_TRACK frames
y	uint16_t	Output	Array of vertical co-ordinates in Q4 format for MAX_NUM_FRAMES_TO_TRACK frames

2.1.1.4 ISOF_ErrorType

|| Description

Error code returned by the SOF algorithm.

|| Fields

Enums	Description
ISOF_ERRORTYPE_MAXLEVELS_EXCEEDED	The number of levels request by user are more than supported by SOF algorithm
ISOF_ERRORTYPE_INVALID_START_XY	The startX and Y are beyond the image boundary
ISOF_ERRORTYPE_INVALID_IMAGE_DIMS	Image dimensions are beyond the supported
ISOF_ERRORTYPE_IMGPYRAMID_CREATE_FAIL	Failure while creating image Pyramid
ISOF_ERRORTYPE_FAST9_CORNER_CREATE_FAIL	Failure while creating fast9 corner detector
ISOF_ERRORTYPE_FAST9_BFFT_CREATE_FAIL	Failure while creating fast9 best feature to front
ISOF_ERRORTYPE_YUV_PADDING_CREATE_FAIL	Failure while creating YUV Padding applet
ISOF_ERRORTYPE_HARRIS_KD_CREATE_FAIL	Failure while creating Harris corner detection applet
ISOF_ERRORTYPE_NOT_VALID_KD_METHOD	Key Point detection method requested user is not supported
ISOF_ERRORTYPE_LK_TRACKER_CREATE_FAIL	Failure while creating Pyramidal LK tracker applet
ISOF_ERRORTYPE_INSUFF_MEM_FOR_IO_BUFFER	Internal Memory requested by the algorithm is not sufficient for the given configuration

2.1.1.5 SOF_KeyPointDetectMethod

|| Description

Key Points detection method supported by SOF algorithm.

|| Fields

Enums	Description
SOF_EXTERNAL_KEY_POINTS	Key points are provided by the user through a input buffer
SOF_HARRIS_KEY_POINTS	Harris key point detector method will be used by the algorithm

Enums	Description
SOF_FAST9_KEY_POINTS	Fast9 key point detector method along with best feature to front will be used by the algorithm

2.1.1.6 Macros

|| Description

Macros used by SOF algorithm.

|| Fields

Macros	Description
SOF_TI_MAXLEVELS	Max levels allowed by SOF
SOF_TI_MAXWIDTH	Max Width allowed by SOF
SOF_TI_MAXHEIGHT	Max Height allowed by SOF
MAX_NUM_FRAMES_TO_TRACK	Number of frames for which the tracking information needs to be maintained by the algorithm. This value shall be power of 2

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